CRMKTL0301A

N-Channel 30V, 1.7mΩ Typ. Power MOSFET

Description

Features

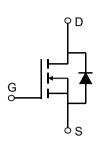
• 30V, 183A

$$R_{DS(ON)}$$
 Typ = 1.7m Ω @ V_{GS} = 10V
 $R_{DS(ON)}$ Typ = 2.55m Ω @ V_{GS} = 4.5V

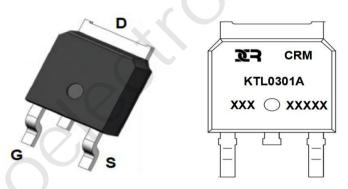
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management







Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTL0301A	CRMKTL0301A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	183	А
I _D		T _C = 100°C	109.8	А
I _{DM}	Pulsed Drain Current (1)		732	А
E _{AS}	Single Pulsed Avalanche Energy (2)		484	mJ
P_{D}	Power Dissipation	T _C = 25°C	125	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.8	2.4	V
	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 20A$	-	1.7	2.2	mΩ
$R_{DS(ON)}$		$V_{GS} = 4.5V, I_D = 15A$	-	2.55	3.3	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(6424	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X - \	841	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11VII 12	-	445	-	pF
Q_g	Total Gate Charge		J -	108	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 30A$	-	20	-	nC
Q_{gd}	Gate Drain("Miller") Charge	VDS = 10 V, 10 = 00/1	-	20	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.rO	-	13	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	29	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$, $R_{GEN} = 3\Omega$	-	85	-	ns
t _f	Turn-Off Fall Time	·	-	50	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	183	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	732	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 204 di/d+ - 4004/:	-	28	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$, di/dt = 100A/us	-	16	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =44A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

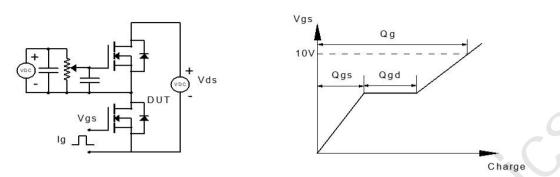


Figure 1: Gate Charge Test Circuit & Waveform

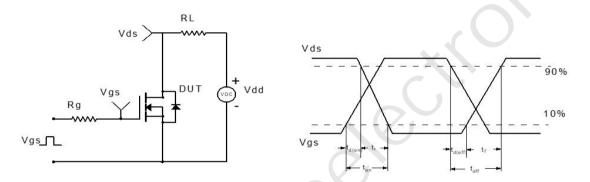


Figure 2: Resistive Switching Test Circuit & Waveform

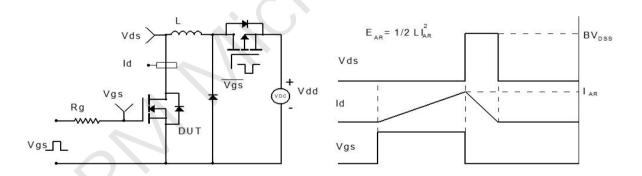


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

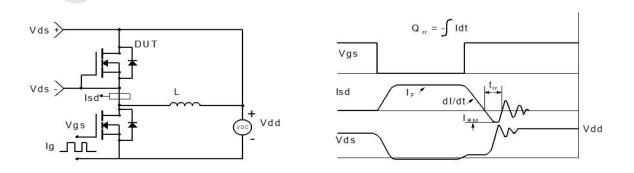
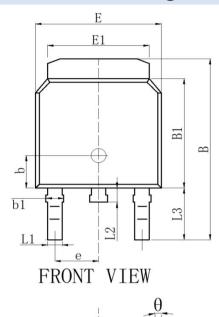


Figure 4: Diode Recovery Test Circuit & Waveform

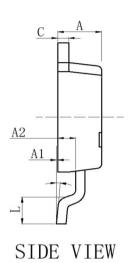
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Package Mechanical Data(TO-252-3L)



BOTTOM VIEW



SYMBOL	MIN	NOM	MAX		
A	2. 20	2. 30	2. 40		
A1	0.00	-	0.10		
A2	0.95	1.00	1.05		
С	0. 508REF				
L	1.40	1.50	1.60		
Е	6. 50	6.60	6. 70		
E1	5. 20	5. 30	5. 40		
В	9. 90	10. 10	10. 30		
B1	6.00	6. 10	6. 20		
b	1. 70	1.80	1. 90		
b1	1. 00MAX				
L1	0.60	0.75	0.90		
L2	0.70	0.90			
L3	2. 95REF				
е	2. 286BSC				
θ	7°				

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